

Logic level N-Channel MOSFET in MLPAK33-WF (SOT8002-3D) 7 May 2025 Pro

Product data sheet

1. General description

Logic level N-Channel MOSFET in a small MLPAK33-WF (SOT8002-3D) package using Trench 9 technology. This product has been designed and qualified to meet AEC-Q101 requirements delivering high performance and reliability.

2. Features and benefits

- Trench 9 technology
- Small footprint (3 x 3 mm) for compact design
- Qualified to AEC-Q101 at 175 °C
- · Side-wettable flanks for robust solder joints and automated optical inspection

3. Applications

- Motor drive
- Battery protection
- DC-DC conversion

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	-	40	V
I _D	drain current	V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	-	62	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	-	53	W
Static chara	cteristics	·				
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 20 A; T _j = 25 °C; Fig. 11	4	5.8	7	mΩ
Dynamic ch	aracteristics					
Q _{GD}	gate-drain charge	$\label{eq:ID} \begin{array}{l} I_D = 15 \text{ A}; \ V_{DS} = 20 \ V; \ V_{GS} = 4.5 \ V; \\ T_j = 25 \ ^\circ\text{C}; \ \overline{\text{Fig. 13}}; \ \overline{\text{Fig. 14}} \end{array}$	-	2.4	4.9	nC



5. Pinning information

Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	S	source						
2	S	source		D				
3	S	source						
4	G	gate						
mb	D	Mounting base; connected to drain	MLPAK33 (SOT8002-3)	mbb076 S				

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
BUK9Q7R0-40H	MLPAK33	plastic thermal enhanced surface mounted package with side-wettable flanks (SWF); mini leads; 8 terminals;pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-3			

7. Marking

Table 4. Marking codes				
Type number	Marking code			
BUK9Q7R0-40H	6AU			

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Tj = 25 °C unless otherwise stated.

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	$25 \text{ °C} \le T_j \le 175 \text{ °C}$	-	40	V
V _{GS}	gate-source voltage		-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	53	W
I _D	drain current	V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	62	А
		V _{GS} = 5 V; T _{mb} = 100 °C; <u>Fig. 2</u>	-	44	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^\circ C$; Fig. 3	-	250	А
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-drai	n diode				_
ls	source current	T _{mb} = 25 °C	-	44	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$	-	250	А

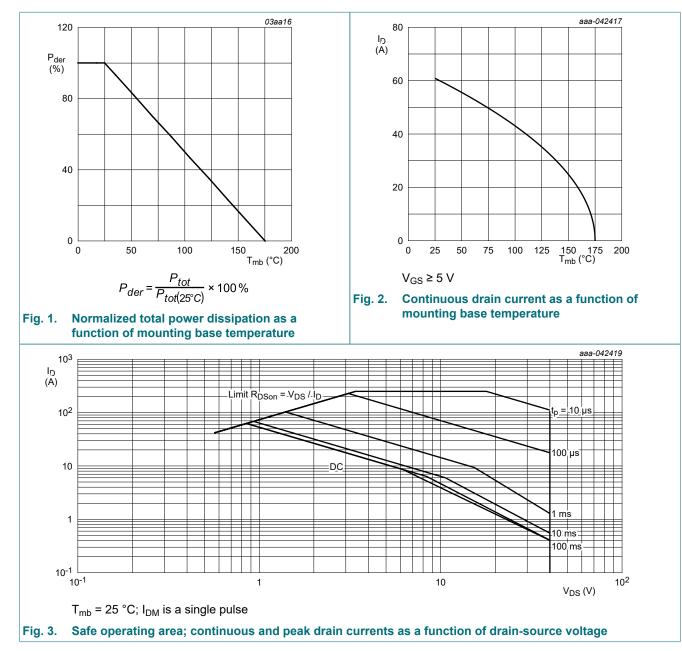
BUK9Q7R0-40H

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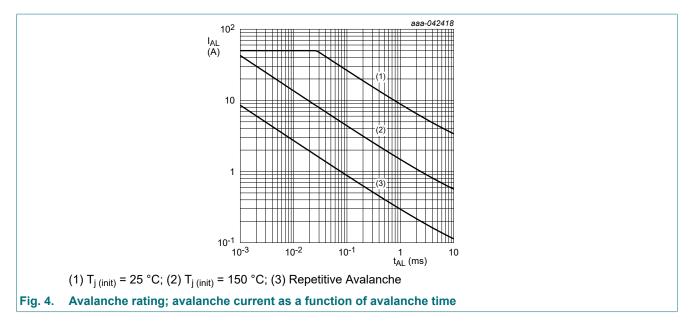
Symbol	Parameter	Conditions		Min	Max	Unit
Avalanche ruggedness						
E _{DS(AL)S}		$ \begin{split} &I_{D} = 26.8 \text{ A}; \text{V}_{\text{sup}} \leq \ 40 \text{ V}; \text{R}_{\text{GS}} = 50 \Omega; \\ &\text{V}_{\text{GS}} = 5 \text{ V}; \text{T}_{\text{j(init)}} = 25 ^{\circ}\text{C}; \text{ unclamped}; \\ &t_{p} = 96 \mu\text{s}; \text{Fig. 4} \end{split} $	[1] [2]	-	67	mJ
I _{AS}	non-repetitive avalanche current	V_{sup} = 40 V; V_{GS} = 5 V; $T_{j(init)}$ = 25 °C; R _{GS} = 50 Ω; <u>Fig. 4</u>	[3]	-	50	A

[1] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

- [2] Refer to application note AN10273 for further information.
- [3] Protected by 100% test



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9. Thermal characteristics

Table 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 5</u>		-	2.35	2.83	K/W
R _{th(j-a)}	thermal resistance from junction to ambient		[1]	-	-	40	K/W

[1] Device on 4 layer PCB. Refer to TN00008 for further information.

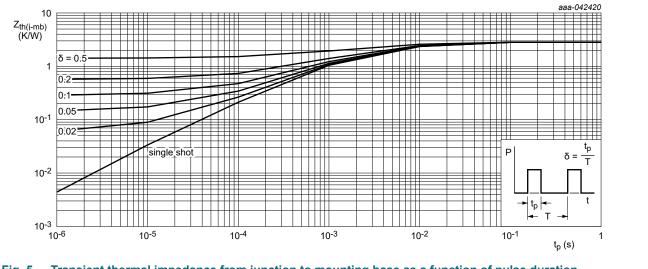


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

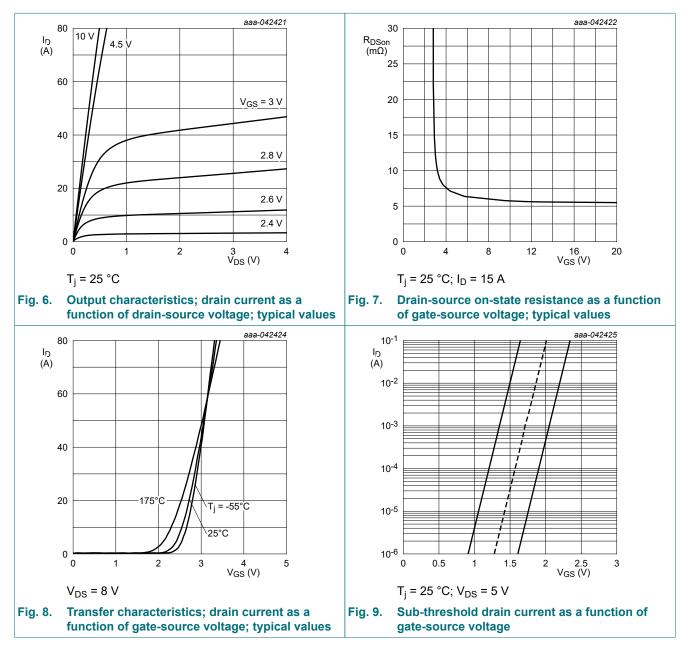
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _i = 25 °C	40	44	-	V
(2.3)200	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _i = -40 °C	-	40.5	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _i = -55 °C	36	40	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; Fig. 9;$ Fig. 10	1.35	1.7	2.05	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; Fig. 10	0.7	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}; Fig. 10$	-	-	2.6	V
DSS	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.002	1	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	-	500	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 20 A; T _j = 25 °C; Fig. 11	4	5.8	7	mΩ
		V _{GS} = 10 V; I _D = 20 A; T _j = 105 °C; Fig. 12	5.7	8.2	10.4	mΩ
		V _{GS} = 10 V; I _D = 20 A; T _j = 125 °C; Fig. 12	6.2	8.9	11.3	mΩ
		V _{GS} = 10 V; I _D = 20 A; T _j = 175 °C; Fig. 12	7.5	10.7	13.4	mΩ
		V _{GS} = 4.5 V; I _D = 20 A; T _j = 25 °C; Fig. 11	5	7.1	9.1	mΩ
		V _{GS} = 4.5 V; I _D = 20 A; T _j = 105 °C; Fig. 12	7	10	13.5	mΩ
		V _{GS} = 4.5 V; I _D = 20 A; T _j = 125 °C; Fig. 12	7.5	10.7	14.7	mΩ
		V _{GS} = 4.5 V; I _D = 20 A; T _j = 175 °C; <u>Fig. 12</u>	9	13	17.4	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.9	2.2	5.5	Ω
Dynamic cł	naracteristics	·				
Q _{G(tot)}	total gate charge	$ I_D = 15 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V}; T_j = 25 ^{\circ}\text{C}; \underline{Fig. 13}; \underline{Fig. 14} $	-	23	32	nC
		$I_D = 15 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 4.5 \text{ V};$	-	10	14.6	nC
Q _{GS}	gate-source charge	T _j = 25 °C; <u>Fig. 13; Fig. 14</u>	-	3.9	5.9	nC
ସ୍ _{GD}	gate-drain charge]	-	2.4	4.9	nC
V _{GS(pl)}	gate-source plateau voltage	I _D = 15 A; V _{DS} = 20 V; T _j = 25 °C; Fig. 13; Fig. 14	-	2.7	-	V
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz;	-	1520	2128	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 15</u>	-	306	428	pF
C _{rss}	reverse transfer capacitance	1	-	65	143	pF
t _{d(on)}	turn-on delay time	V_{DS} = 20 V; R _L = 1.333 Ω; V _{GS} = 4.5 V;	-	11	-	ns
t _r	rise time	R _{G(ext)} = 5 Ω; T _j = 25 °C	-	12	-	ns

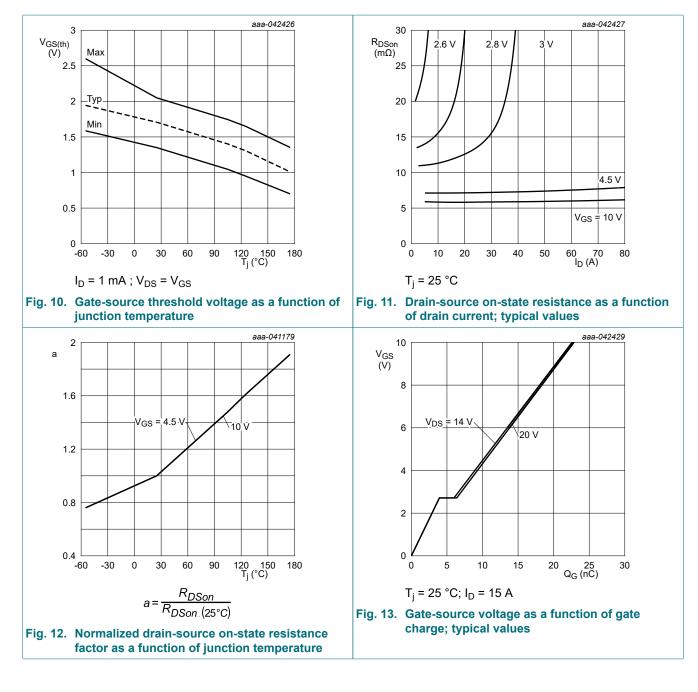
Logic level N-Channel MOSFET in MLPAK33-WF (SOT8002-3D)

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
t _{d(off)}	turn-off delay time			-	16	-	ns
t _f	fall time			-	8	-	ns
Source-drai	in diode				_		
V _{SD}	source-drain voltage	I_{S} = 20 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 16</u>		-	0.8	1.2	V
t _{rr}	reverse recovery time	I_{S} = 12 A; dI _S /dt = -100 A/µs; V _{GS} = 0 V;		-	19	-	ns
Q _r	recovered charge	V _{DS} = 20 V; T _j = 25 °C; <u>Fig. 17</u>	[1]	-	10	-	nC

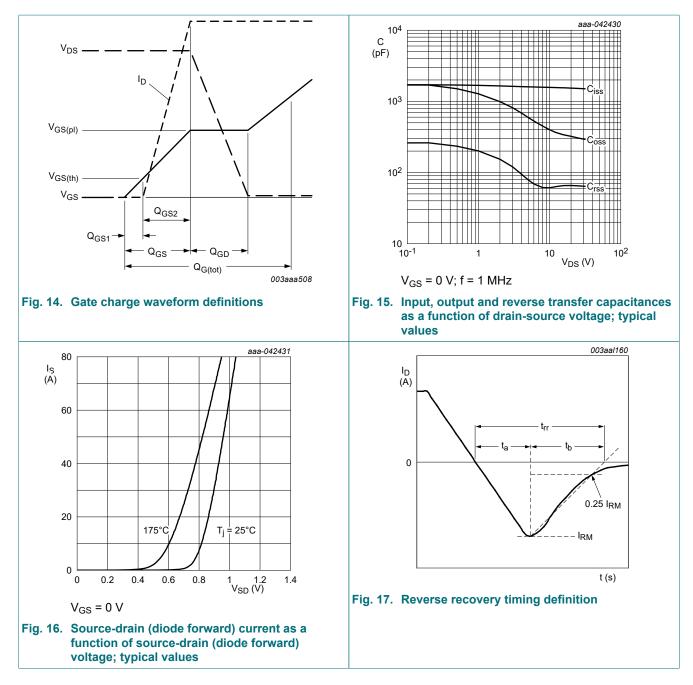
[1] includes capacitive recovery



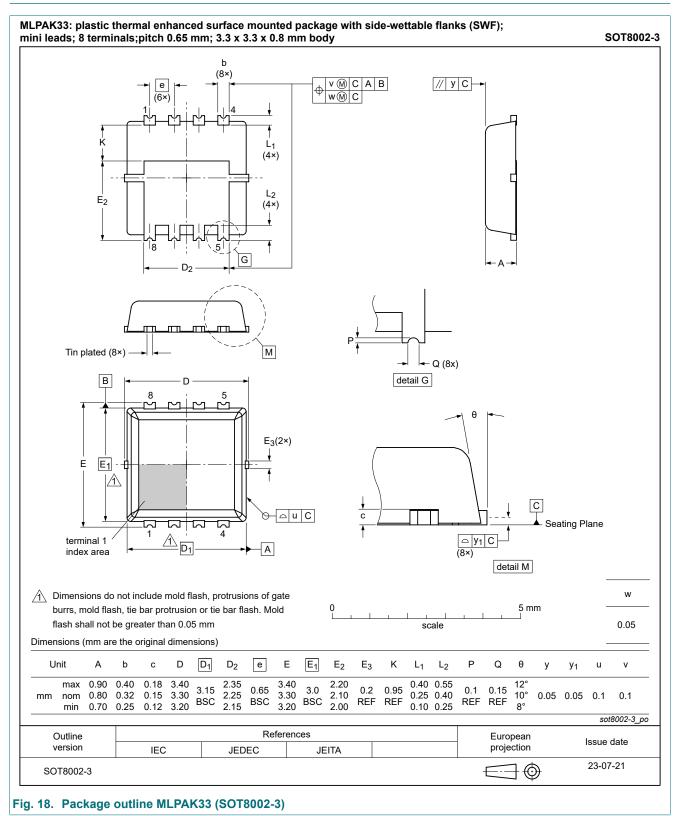
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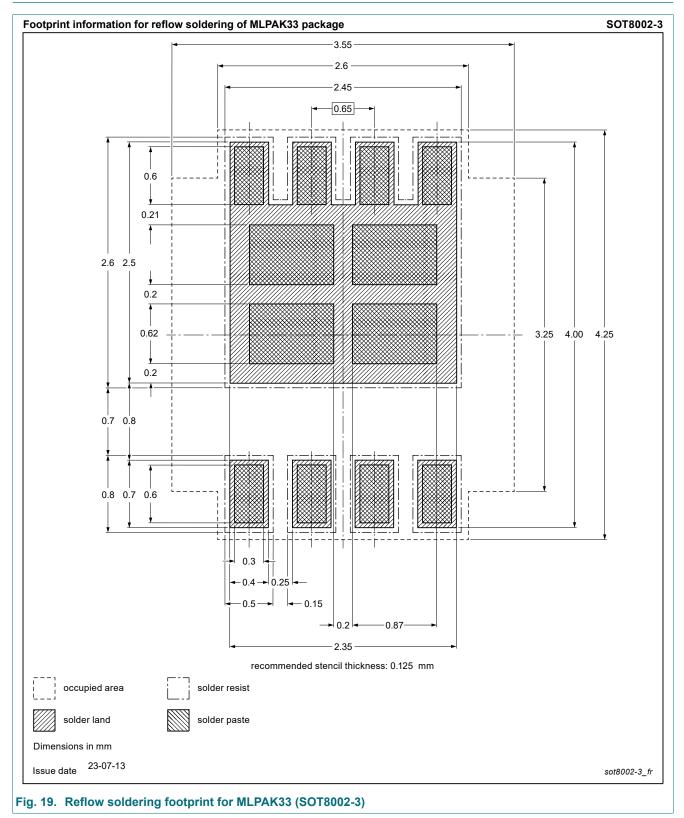
Logic level N-Channel MOSFET in MLPAK33-WF (SOT8002-3D)



11. Package outline



12. Soldering



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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